

# BUV21

## SWITCHMODE™ Series NPN Silicon Power Transistor

This device is designed for high speed, high current, high power applications.

### Features

- High DC Current Gain:  
 $h_{FE} \text{ min} = 20$  at  $I_C = 12 \text{ A}$
- Low  $V_{CE(sat)}$ ,  $V_{CE(sat)}$   
 $\text{max} = 0.6 \text{ V}$  at  $I_C = 8 \text{ A}$
- Very Fast Switching Times:  
 $T_F \text{ max} = 0.4 \mu\text{s}$  at  $I_C = 25 \text{ A}$
- These are Pb-Free Devices\*

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO(SUS)}$	200	Vdc
Collector-Base Voltage	$V_{CBO}$	250	Vdc
Emitter-Base Voltage	$V_{EBO}$	7	Vdc
Collector-Emitter Voltage ( $V_{BE} = -1.5 \text{ V}$ )	$V_{CEX}$	250	Vdc
Collector-Emitter Voltage ( $R_{BE} = 100 \Omega$ )	$V_{CER}$	240	Vdc
Collector-Current - Continuous	$I_C$	40	Adc
- Peak ( $PW \leq 10 \text{ ms}$ )	$I_{CM}$	50	Apk
Base-Current Continuous	$I_B$	8	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$	$P_D$	250	W
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to 200	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$\theta_{JC}$	0.7	$^\circ\text{C/W}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

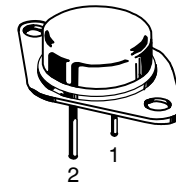
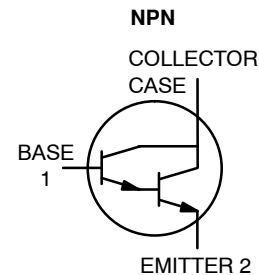
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

<http://onsemi.com>

**40 AMPERES  
NPN SILICON POWER  
METAL TRANSISTOR  
200 VOLTS – 250 WATTS**



TO-204AE (TO-3)  
CASE 197A  
STYLE 1

### MARKING DIAGRAM



BUV21 = Device Code  
G = Pb-Free Package  
A = Assembly Location  
Y = Year  
WW = Work Week  
MEX = Country of Origin

### ORDERING INFORMATION

Device	Package	Shipping
BUV21G	TO-204 (Pb-Free)	100 Units / Tray

# BUV21

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Max	Unit
----------------	--------	-----	-----	------

### OFF CHARACTERISTICS (Note 1)

Collector-Emitter Sustaining Voltage ( $I_C = 200\text{ mA}$ , $I_B = 0$ , $L = 25\text{ mH}$ )	$V_{CEO(sus)}$	200		Vdc
Collector Cutoff Current at Reverse Bias: ( $V_{CE} = 250\text{ V}$ , $V_{BE} = -1.5\text{ V}$ ) ( $T_C = 25^\circ\text{C}$ unless otherwise noted) ( $V_{CE} = 250\text{ V}$ , $V_{BE} = -1.5\text{ V}$ , $T_C = 125^\circ\text{C}$ )	$I_{CEX}$		3.0 12.0	mAdc
Collector-Emitter Cutoff Current ( $V_{CE} = 160\text{ V}$ )	$I_{CEO}$		3.0	mAdc
Emitter-Base Reverse Voltage ( $I_E = 50\text{ mA}$ )	$V_{EBO}$	7		V
Emitter-Cutoff Current ( $V_{EB} = 5\text{ V}$ )	$I_{EBO}$		1.0	mAdc

### SECOND BREAKDOWN

Second Breakdown Collector Current with base forward biased ( $V_{CE} = 20\text{ V}$ , $t = 1\text{ s}$ ) ( $V_{CE} = 140\text{ V}$ , $t = 1\text{ s}$ )	$I_{S/b}$	12 0.15		Adc
--	-----------	------------	--	-----

### ON CHARACTERISTICS (Note 1)

DC Current Gain ( $I_C = 12\text{ A}$ , $V_{CE} = 2\text{ V}$ ) ( $I_C = 25\text{ A}$ , $V_{CE} = 4\text{ V}$ )	$h_{FE}$	20 10	60	
Collector-Emitter Saturation Voltage ( $I_C = 12\text{ A}$ , $I_B = 1.2\text{ A}$ ) ( $I_C = 25\text{ A}$ , $I_B = 3\text{ A}$ )	$V_{CE(sat)}$		0.6 1.5	Vdc
Base-Emitter Saturation Voltage ( $I_C = 25\text{ A}$ , $I_B = 3\text{ A}$ )	$V_{BE(sat)}$		1.5	Vdc

### DYNAMIC CHARACTERISTICS

Current Gain - Bandwidth Product ( $V_{CE} = 15\text{ V}$ , $I_C = 2\text{ A}$ , $f = 4\text{ MHz}$ )	$f_T$	8.0		MHz
--	-------	-----	--	-----

### SWITCHING CHARACTERISTICS (Resistive Load)

Turn-on Time	( $I_C = 25\text{ A}$ , $I_{B1} = I_{B2} = 3\text{ A}$ , $V_{CC} = 100\text{ V}$ , $R_C = 4\ \Omega$ )	$t_{on}$	1.0	$\mu\text{s}$
Storage Time		$t_s$	1.8	
Fall Time		$t_f$	0.4	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

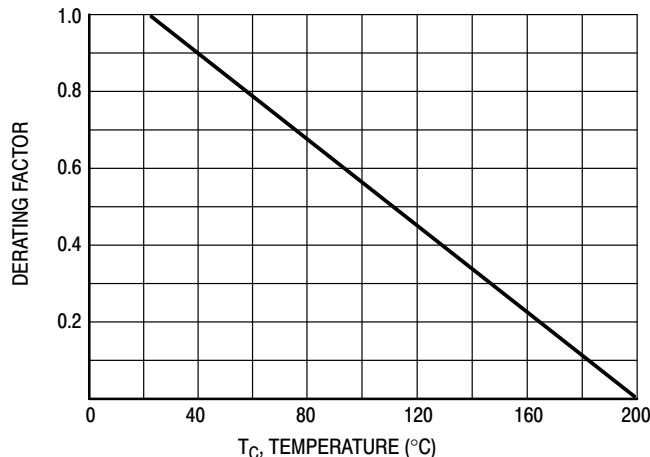


Figure 1. Power Derating

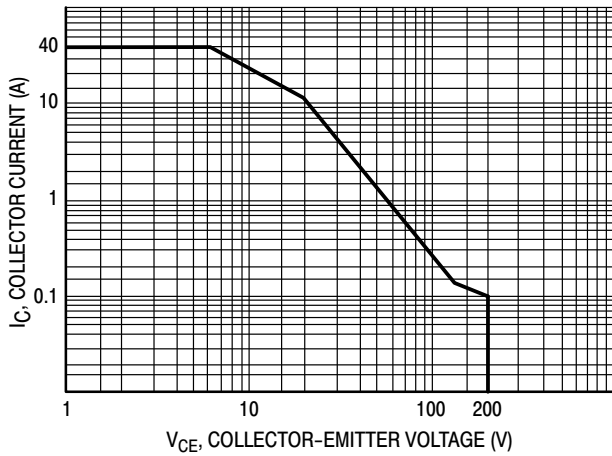


Figure 2. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on  $T_C = 25^\circ C$ ,  $T_{J(pk)}$  is variable depending on power level. Second breakdown limitations do not derate the same as thermal limitations.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

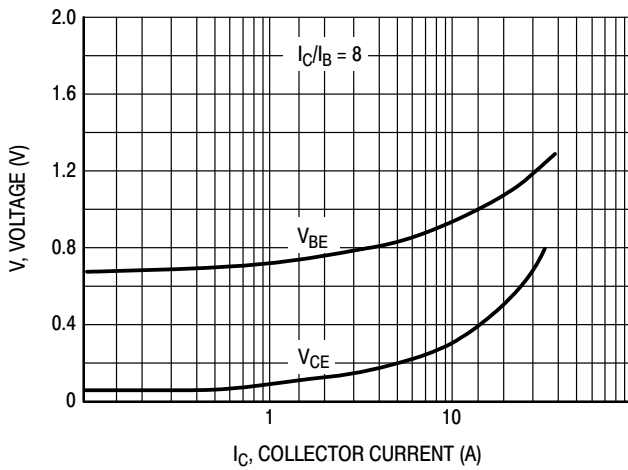


Figure 3. "On" Voltages

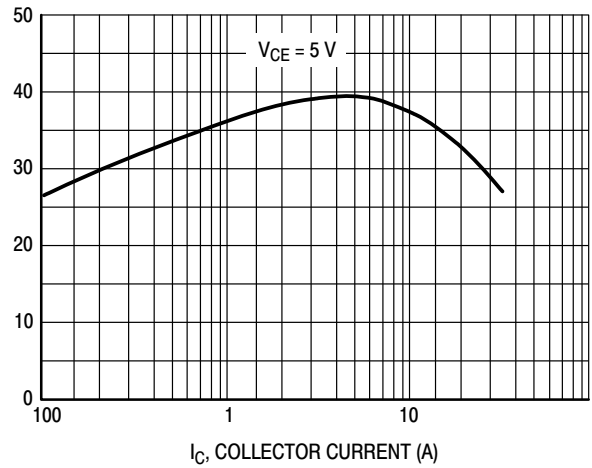


Figure 4. DC Current Gain

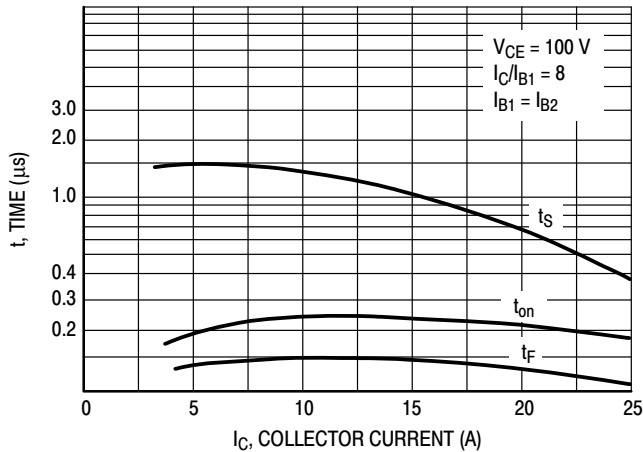
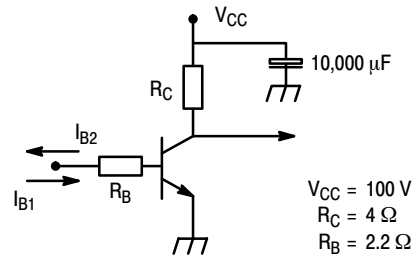


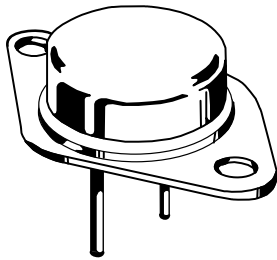
Figure 5. Resistive Switching Performance



$R_C - R_B$ : Non inductive resistances

$V_{CC} = 100 V$   
 $R_C = 4 \Omega$   
 $R_B = 2.2 \Omega$

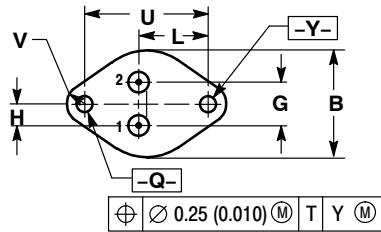
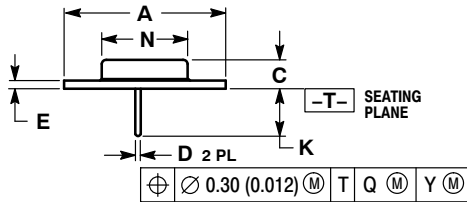
Figure 6. Switching Times Test Circuit



SCALE 1:1

TO-204 (TO-3)  
CASE 197A-05  
ISSUE K

DATE 21 FEB 2000

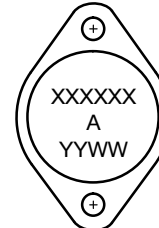


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.530 REF		38.86 REF	
B	0.990	1.050	25.15	26.67
C	0.250	0.335	6.35	8.51
D	0.057	0.063	1.45	1.60
E	0.060	0.070	1.53	1.77
G	0.430 BSC		10.92 BSC	
H	0.215 BSC		5.46 BSC	
K	0.440	0.480	11.18	12.19
L	0.665 BSC		16.89 BSC	
N	0.760	0.830	19.31	21.08
Q	0.151	0.165	3.84	4.19
U	1.187 BSC		30.15 BSC	
V	0.131	0.188	3.33	4.77

GENERIC  
MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
A = Assembly Location  
YY = Year  
WW = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:

PIN 1. BASE  
2. EMITTER  
CASE: COLLECTOR

STYLE 2:

PIN 1. EMITTER  
2. BASE  
CASE: COLLECTOR

STYLE 3:

PIN 1. GATE  
2. SOURCE  
CASE: DRAIN

STYLE 4:

PIN 1. ANODE = 1  
2. ANODE = 2  
CASE: CATHODES

DOCUMENT NUMBER:	98ASB42129B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	TO-204 (TO-3)	PAGE 1 OF 1

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

**onsemi**, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

---

## ADDITIONAL INFORMATION

### TECHNICAL PUBLICATIONS:

Technical Library: [www.onsemi.com/design/resources/technical-documentation](http://www.onsemi.com/design/resources/technical-documentation)  
onsemi Website: [www.onsemi.com](http://www.onsemi.com)

### ONLINE SUPPORT: [www.onsemi.com/support](http://www.onsemi.com/support)

For additional information, please contact your local Sales Representative at [www.onsemi.com/support/sales](http://www.onsemi.com/support/sales)